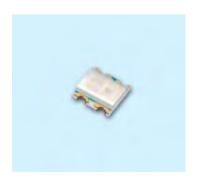
EVERLIGHT AMERICAS

DATASHEET

EAST1613GOA0



Features

- Package in 8mm tape on 7" diameter reel.
- Compatible with automatic placement equipment.
- Compatible with infrared and vapor phase reflow solder process.
- Multi-color type.
- Pb-free.
- The product itself will remain within RoHS compliant version.

Descriptions

- The EAST1613 SMD LED is much smaller than lead frame type components, thus enable smaller board size, higher packing density, reduced storage space and finally smaller equipment to be obtained.
- Besides, lightweight makes them ideal for miniature applications. etc.

Applications

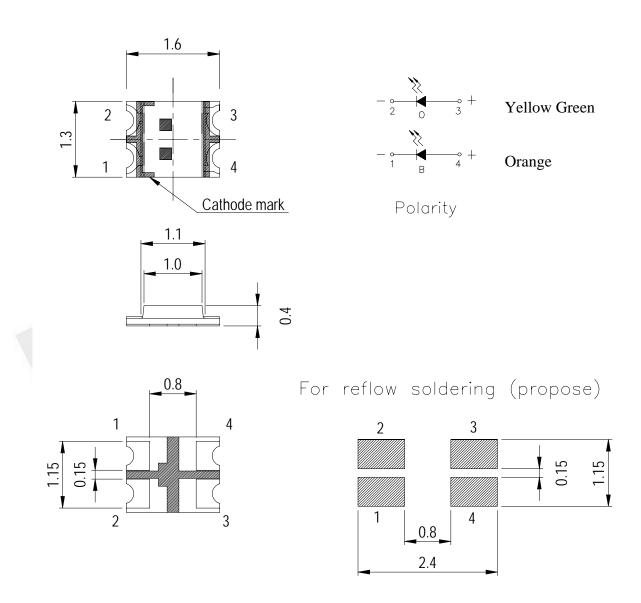
- Backlighting in dashboard and switch.
- Telecommunication: indicator and backlighting in telephone and fax.
- Flat backlight for LCD, switch and symbol.
- General use.



Device Selection Guide

Chip			D . G .
Type Material Emitted Color		Resin Color	
G7	AlGaInP	Brilliant Yellow Green	W. Cl
S2	AlGaInP	Brilliant Orange	Water Clear

Package Outline Dimensions



Note: The tolerances unless mentioned is ± 0.1 mm, Unit = mm



Absolute Maximum Ratings (Ta=25 $^{\circ}$ C)

Parameter	Symbol	Rating	Unit	
Reverse Voltage	V_R	5	V	
Forward Current	IF	G7:25 S2:25	mA	
Peak Forward Current (Duty 1/10 @1KHz)	Ifp	G7:60 S2:60	mA	
Power Dissipation	Pd	G7:60 S2:60	mW	
Electrostatic Discharge(HBM)	ESD	G7:2000 S2:2000	V	
Operating Temperature	Topr	-40 ~ +85	$^{\circ}\!\mathbb{C}$	
Storage Temperature	Tstg	-40 ~ +90	$^{\circ}$	
Soldering Temperature	Tsol	Reflow Soldering: 260 °C for 10 sec. Hand Soldering: 350 °C for 3 sec.		



Electro-Optical Characteristics (Ta=25 $^{\circ}$ C)

Parameter	Sym	bol	Min.	Тур.	Max.	Unit	Condition
Luminous Intensity	Iv	G7 S2	22.5 45		57 112	mcd	I _F =20mA
Viewing Angle	2θ 1	1/2		120		deg	I _F =20mA
Peak Wavelength	λр	G7 S2		575 611		nm	IF=20mA
Dominant Wavelength	λd	G7 S2	567.5 599		575.5 613	nm	IF=20mA
Spectrum Radiation Bandwidth	Δλ	G7 S2	0	20 17		nm	IF=20mA
Forward Voltage	VF	G7 S2	1.7 1.7	2.0 2.0	2.4 2.4	V	IF=20mA
Reverse Current	IR	G7 S2			10 10	μ A	VR=5V

Notes:

- 1.Tolerance of Luminous Intensity ±11%
- 2.Tolerance of Dominant Wavelength ±1nm



G7 Bin Range Of Luminous Intensity

Bin	Min	Max	Unit	Condition
M2	22.5	28.5	_	IF=20mA
N1	28.5	36.0		
N2	36.0	45.0	mcd	
P1	45.0	57.0		

Bin Range Of Dom. Wavelength

Bin	Min	Max	Unit	Condition
1	567.5	569.5	nm	I _F =20mA
2	569.5	571.5		
3	571.5	573.5		
4	573.5	575.5		

S2

Bin Range Of Luminous Intensity

Bin	Min	Max	Unit	Condition	
P1	45	57			
P2	57	72	1	T 20 A	
Q1	72	90	mcd	IF=20mA	
Q2	90	112			

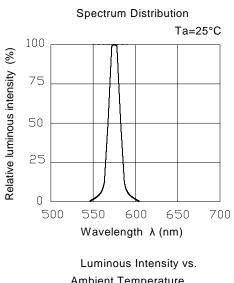
Notes:

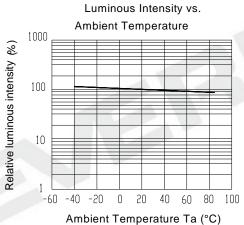
- 1.Tolerance of Luminous Intensity ±11%
- 2.Tolerance of Dominant Wavelength ±1nm

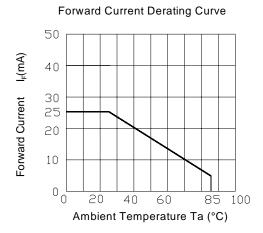


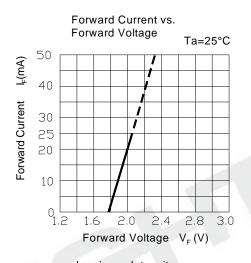
Typical Electro-Optical Characteristics Curves

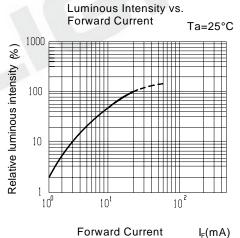
G7

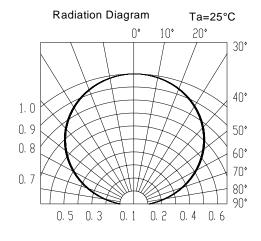








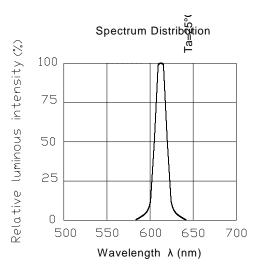


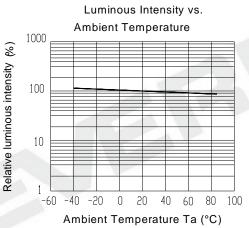


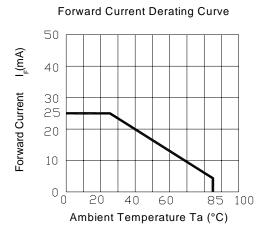


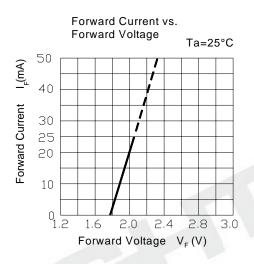
Typical Electro-Optical Characteristics Curves

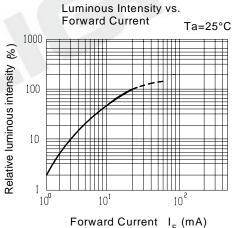
S2

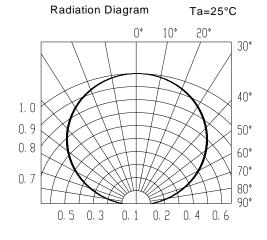












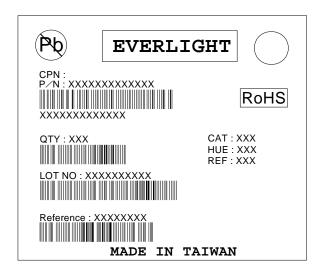


Label Explanation

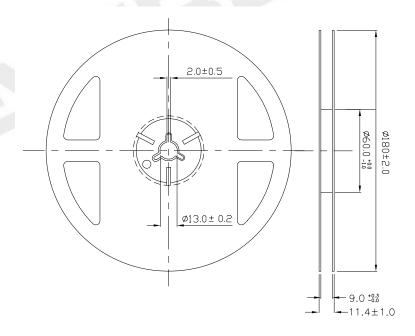
CAT: Luminous Intensity Rank

HUE: Dom. Wavelength Rank

REF: Forward Voltage Rank



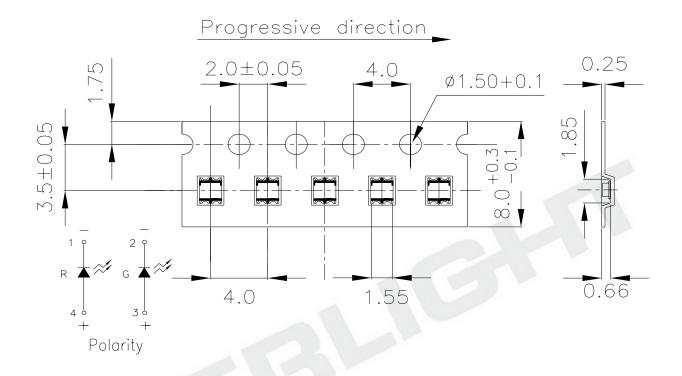
Reel Dimensions



Note: The tolerances unless mentioned is ± 0.1 mm, Unit = mm

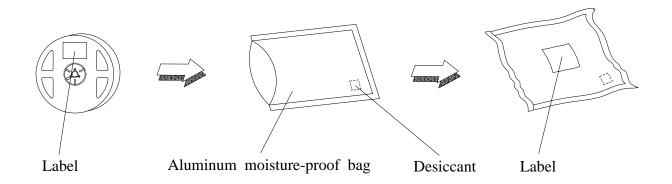


Carrier Tape Dimensions: Loaded quantity 2000 PCS per reel



Note: The tolerances unless mentioned is ± 0.1 mm, Unit = mm

Moisture Resistant Packaging





Reliability Test Items And Conditions

The reliability of products shall be satisfied with items listed below.

Confidence level: 90%

LTPD: 10%

No.	Items	Test Condition	Test Hours/Cycles	Sample Size	Ac/Re
1	Reflow Soldering	Temp. : 260°C±5°C Max. 10sec.	6 Min.	22 PCS.	0/1
2	Temperature Cycle	$H: +100^{\circ}\mathbb{C}$ 15min $\int 5 \text{ min}$ $L: -40^{\circ}\mathbb{C}$ 15min	300 Cycles	22 PCS.	0/1
3	Thermal Shock	$H: +100^{\circ}\mathbb{C}$ 5min $\int 10 \sec$ $L: -10^{\circ}\mathbb{C}$ 5min	300 Cycles	22 PCS.	0/1
4	High Temperature Storage	Temp. : 100°C	1000 Hrs.	22 PCS.	0/1
5	Low Temperature Storage	Temp. : -40°C	1000 Hrs.	22 PCS.	0/1
6	DC Operating Life	$I_F = 20 \text{ mA}$	1000 Hrs.	22 PCS.	0/1
7	High Temperature / High Humidity	85°C / 85%RH	1000 Hrs.	22 PCS.	0/1



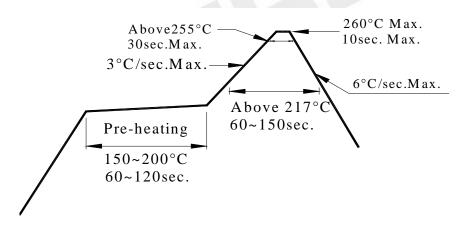
Precautions For Use

1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

- 2. Storage
 - 2.1 Do not open moisture proof bag before the products are ready to use.
 - 2.2 Before opening the package: The LEDs should be kept at 30° C or less and 90%RH or less.
 - 2.3 After opening the package: The LED's floor life is 1 year under 30°C or less and 60% RH or less. If unused LEDs remain, it should be stored in moisture proof packages.
 - 2.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

 Baking treatment: 60±5°C for 24 hours.
- 3. Soldering Condition
 - 3.1 Pb-free solder temperature profile



- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.



4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350°C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.

